UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO.

: 7,185,307 B2 '

Page 1 of 1

APPLICATION NO.: 10/708256

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INVENTOR(S)

: Hsin-Shih Wang

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the title page item (54), and col. 1, line 1, change

"METHOD OF FABRICATING AND INTEGRATED CIRCUIT THROUGH UTILIZING METAL LAYERS TO PROGRAM RANDOMLY POSITIONED **BASIC UNITS"**

to

--METHOD OF FABRICATING AN INTEGRATED CIRCUIT THROUGH UTILIZING METAL LAYERS TO PROGRAM RANDOMLY POSITIONED **BASIC UNITS--**

Signed and Sealed this

Eighth Day of May, 2007

JON W. DUDAS Director of the United States Patent and Trademark Office